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TAIWAN SEMICONDUCTOR MANUFACTURING CO LTD Form 6-K May 14, 2013

1934 Act Registration No. 1-14700

SECURITIES AND EXCHANGE COMMISSION

Washington, DC 20549

FORM 6-K

REPORT OF FOREIGN PRIVATE ISSUER

PURSUANT TO RULE 13a-16 OR 15d-16 OF

THE SECURITIES EXCHANGE ACT OF 1934

For the month of May 2013

Taiwan Semiconductor Manufacturing Company Ltd.

(Translation of Registrant s Name Into English)

No. 8, Li-Hsin Rd. 6,

Hsinchu Science Park,

Taiwan

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(Address of Principal Executive Offices)

(Indicate by check mark whether the registrant files or will fil	le annual repor	ts under cover of Form 20-F or Form 40-F.)			
Form	20-F x	Form 40-F			
(Indicate by check mark whether the registrant by furnishing the information contained in this form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934.)					
	Yes "	No x			
(If Yes is marked, indicated below the file number assigne	d to the registr	ant in connection with Rule 12g3-2(b): 82:	.)		

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SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Taiwan Semiconductor Manufacturing Company Ltd.

Date: May 14, 2013

By /s/ Lora Ho Lora Ho Senior Vice President & Chief Financial Officer

TSMC Board of Directors Meeting Resolutions

Hsinchu, Taiwan, R.O.C. May 14, 2013 TSMC (NYSE: TSM) today held a meeting of the Board of Directors, which passed the following resolutions:

- 1. Approved capital appropriations totaling approximately US4,901.9 million for the purpose of R&D and capacity expansion for advanced process technologies, construction of 12-inch GigaFab facilities, and installation of facility systems.
- 2. Approved the issuance of unsecured straight corporate bonds in the domestic market for an amount not exceeding NT\$45 billion to raise capital for capacity expansion.

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TSMC Spokesperson: Ms. Lora Ho	TSMC Acting Spokesperson: Dr. Elizabeth Sun	For Further Information: Mr. Michael Kramer	Ms. Dana Tsai
Senior Vice President and CFO	mor vice resident and Breezer		Principal Specialist
Tel: 886-3-566-4602	Corporate Communication Division	PR Department	PR Department
	Tel: 886-3-568-2085	Tel: 03-563-6688 ext. 7125031	Tel: 886-3-505-5036
	Mobile: 886-988-937999	Mobile: 886-988-931-352	Mobile: 886-988-931-351
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